

**Amendments to the Claims**

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TJB 7/10/04

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

Claims 1 – 12 (Canceled).

Claim 13 (Currently amended): Semiconductor device manufacturing equipment comprising:

~~A~~ a transfer chamber having a first side and a second side located directly across the interior of the transfer chamber from said first side, said first and second sides of said transfer chamber extending in vertical planes, respectively, that are parallel to one another;

a plurality of load lock chambers connected to said transfer chamber independently of each other at said first side of the transfer chamber, some of said loadlock chambers being disposed at a plurality of levels, respectively, at said first side of said transfer chamber, a number of said ~~load-lock~~ load lock chambers being disposed side-by-side as oriented parallel to one another and spaced relative to each other in a first axial direction on at least one of said levels, the first axial direction lying parallel to the planes in which said first and second sides of the transfer chamber lie, and each of said load lock chambers having first and second doors that separate